May 2011

FDMS86102LZ N-Channel Power Trench[®] MOSFET 100 V, 22 A, 25 mΩ

Features

- Max $r_{DS(on)} = 25 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 7 \text{ A}$
- Max r_{DS(on)} = 37 mΩ at V_{GS} = 4.5 V, I_D = 5.8 A
- HBM ESD protection level > 6 KV typical (Note 4)
- 100% UIL Tested
- RoHS Compliant

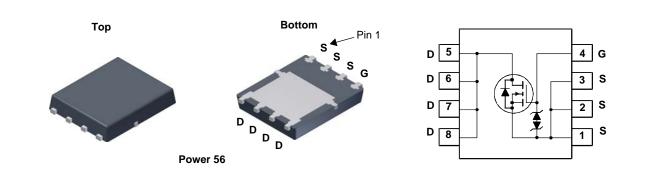


General Description

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been special tailored to minimize the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

Applications

- DC DC Conversion
- Inverter
- Synchronous Rectifier



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

FDMS86102LZ

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage	to Source Voltage			V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Packa	age limited) T _C = 25 °	С	22		
	-Continuous (Silico	on limited) $T_{\rm C} = 25$	С	37		
	-Continuous	T _A = 25 °	C (Note 1a)	7	Α	
	-Pulsed			40		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ	
P _D	Power Dissipation	T _C = 25 °	C	69	W	
	Power Dissipation	T _A = 25 °	C (Note 1a)	2.5	VV	
T _J , T _{STG}	Operating and Storage Junction Te	Operating and Storage Junction Temperature Range			°C	
	aracteristics					
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case 1.8				°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient(Note 1a)50			0,11		
Package Ma	arking and Ordering Informa	ation				
Device Ma	rking Device	Package	Reel Size	Tape Width	Quantity	

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FDMS86102Z

FDMS86102LZ Rev.C

Power 56

13 "

12 mm

3000 units

FDMS86102LZ
N-Channel
Power Trenc
h [®] MOSFET

BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
ΔBV _{DSS}	Breakdown Voltage Temperature	$I_D = 250 \ \mu$ A, referenced to 25 °C		70		mV/°C
ΔT_{J}	Coefficient			70		IIIV/ C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.5	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \ I_D = 7 \text{ A}$		18.6	25	
r _{DS(on)}		$V_{GS} = 4.5 \text{ V}, \ I_D = 5.8 \text{ A}$		23.5	37	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}, T_J = 125 \text{ °C}$		31.2	42	
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 7 A$		26		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			979	1305	pF
C _{oss}	Output Capacitance	$V_{\rm DS} = 50 \text{ V}, V_{\rm GS} = 0 \text{ V},$		175	235	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		8.9	15	pF
R _g	Gate Resistance		1	0.9		Ω
*	a Charactoristics					
	g Characteristics Turn-On Delay Time			6.7	14	ns
t _{d(on)}	Rise Time			2.6	10	ns
<u>t</u>	Turn-Off Delay Time	$V_{DD} = 50$ V, $I_D = 7$ A, $V_{GS} = 10$ V, $R_{GEN} = 6$ Ω		19	35	ns
t _{d(off)}	Fall Time	VGS = 10 V, KGEN = 0.32		2.5	10	ns
<u>Ч</u>	Total Gate Charge	$V_{\rm ex} = 0.01$ to 10.01		16	22	nC
Q _{g(TOT)}	Total Gate Charge	$ \begin{array}{c} V_{GS} = 0 \ V \ to \ 10 \ V \\ V_{GS} = 0 \ V \ to \ 4.5 \ V \\ I_D = 7 \ A \end{array} \\ \end{array} \\ \begin{array}{c} V_{DD} = 50 \ V, \\ I_D = 7 \ A \end{array} $		7.8	11	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0$ V to 4.3 V $I_D = 7$ A		2.4		nC
Q _{gs}	Gate to Drain "Miller" Charge	-		2.4		nC
Q _{gd}				2.0		no
Drain-So	urce Diode Characteristics	V _{GS} = 0 V, I _S = 7 A (Note 2)		0.81	1.3	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 7 A$ (Note 2) $V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.81	1.3	V
+	Reverse Recovery Time	VGS = 0 V, IS = 2 A (Note 2)		35	57	ns
t _{rr} Q _{rr}	Reverse Recovery Charge	— I _F = 7 A, di/dt = 100 A/μs		25	40	nC
NOTES:	mined with the device mounted on a 1 in ² pad 2 oz copper pa	ad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is	guaranteed b			
	a. 50 °C/W when mounted on a 1 in ² pad of 2 oz copper		b	b. 125 °C/W when mounted on a minimum pad of 2 oz copper		
2. Pulse Test: P	Pulse Width < 300 μs, Duty cycle < 2.0%. 25 °C; N-ch: L = 1 mH, I _{AS} = 13 A, V _{DD} = 90 V, V _{GS} = 10 V.					

Test Conditions

Min

Тур

Мах

Units

Electrical Characteristics T_J = 25 °C unless otherwise noted

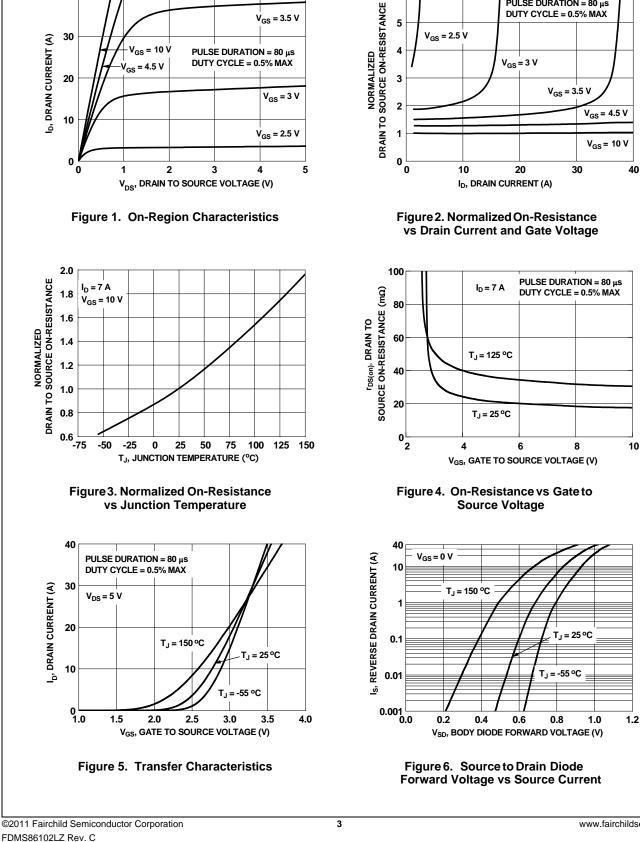
Parameter

Symbol

Off Characteristics

PULSE DURATION = 80 µs

DUTY CYCLE = 0.5% MAX

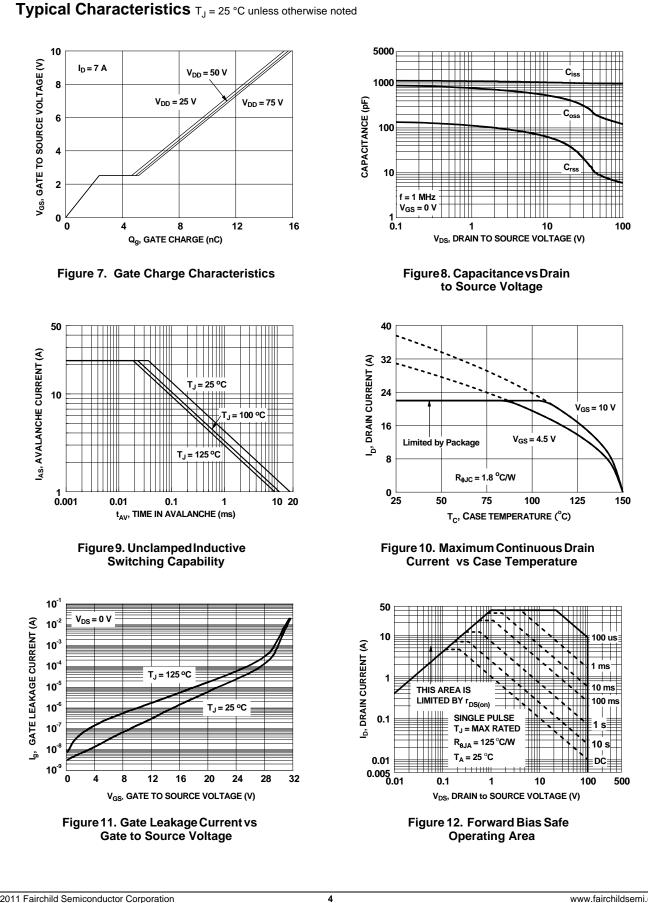


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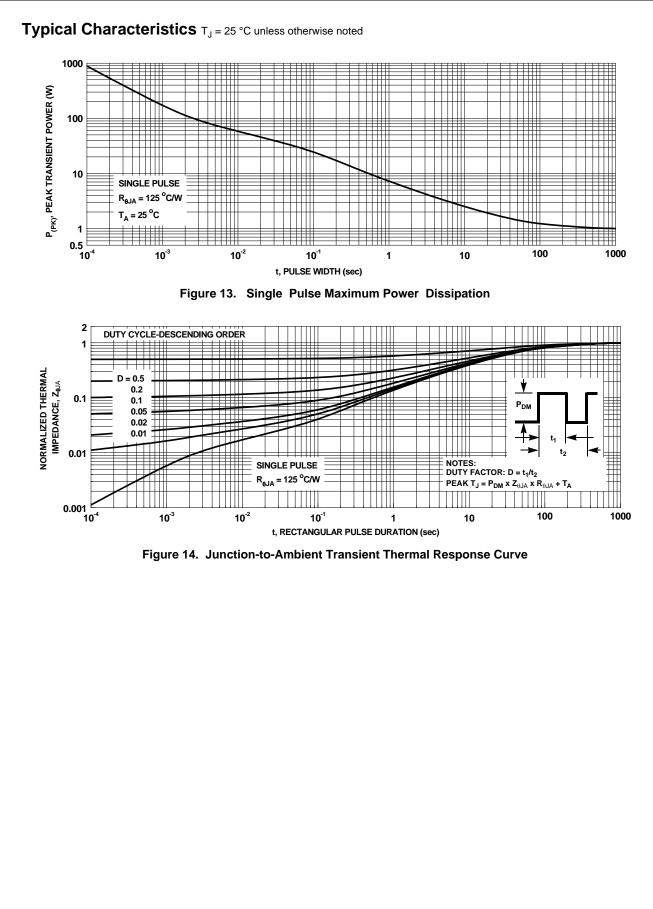
Typical Characteristics T_J = 25 °C unless otherwise noted

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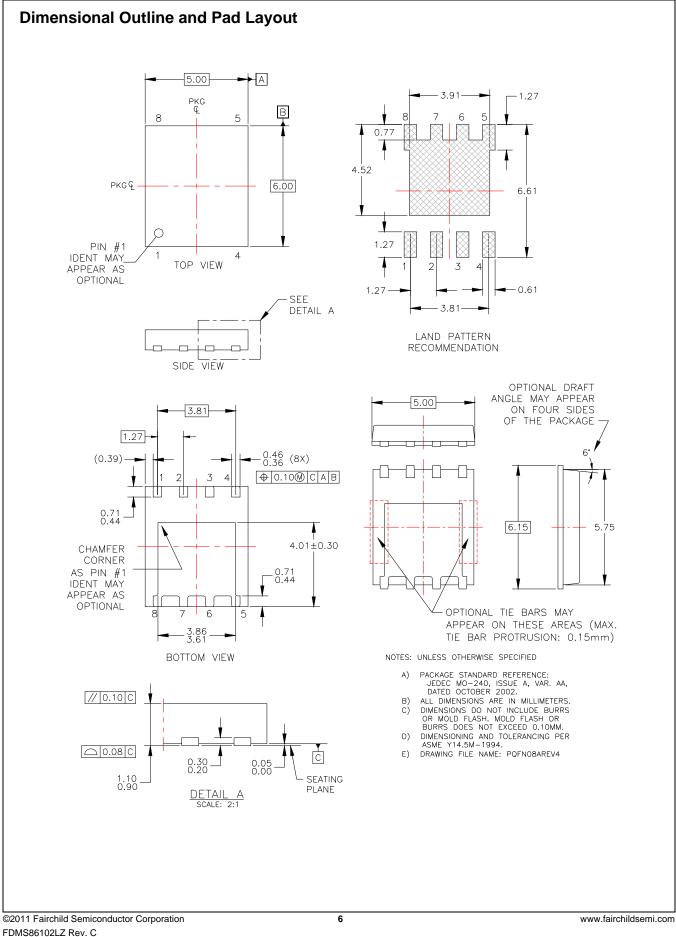




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